# FP1309B

# High frequency, high current power inductors



#### **Product description**

- · High current carrying capacity
- · Low core loss
- Tight tolerance DCR for sensing circuits
- Inductance Range from 100nH to 150nH
- Current range from 60 to 100 amps
- 12.8 x 8.3mm footprint surface mount package in an 8.8mm height
- · Ferrite core material
- Halogen free, lead free, RoHS compliant

## **Applications**

- Servers
- Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs)
  - Server and desktop
  - Central processing unit (CPU)
  - Graphics processing unit (GPU)
  - Application specific integrated circuit (ASIC)
  - High power density
- Data centers, networking and storage systems
- · Point-of-Load modules
- · DCR Sensing circuits

#### **Environmental data**

- Storage temperature range (Component): -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant









## **Product specifications**

Part Number <sup>7</sup>	OCL <sup>1</sup> (nH)±10%	FLL <sup>2</sup> (nH) minimum	l <sub>rms</sub> <sup>3</sup> (amps)	l <sub>sat</sub> 1 <sup>4</sup> (amps)	I <sub>sat</sub> 2 <sup>5</sup> (amps)	DCR (mΩ) ±5% @ 20°C	K-factor <sup>6</sup>
B1 version	'	,			,	'	'
FP1309B1-R100-R	100	72	60	100	80	0.19	296
FP1309B1-R120-R	120	87	60	90	72	0.19	296
FP1309B1-R150-R	150	108	60	80	64	0.19	296

- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1Vrms, 0.0Adc, +25°C
- 2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1Vrms, I at 1, +25°C
- 3. I<sub>max</sub>: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 4. I ... 1: Peak current for approximately 20% rolloff @ +25°C
- 5. | Seat 2: Peak current for approximately 20% rolloff @ +125°C

- 6. K-factor: Used to determine Bp-p for core loss (see graph). Bp-p = K \* L \*  $\Delta$ I \* 10<sup>3</sup>. Bp-p:(Gauss), K: (K-factor from table), L: (Inductance in nH),  $\Delta$ I (Peak to peak ripple current in Amps).
- 7. Part Number Definition: FP1309Bx-Rxxx-R

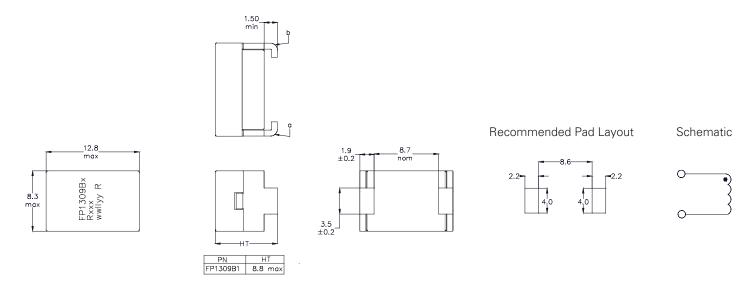
FP1309B= Product code and size

x= Version indicator

Rxxx= Inductance value in  $\mu H$ , R= decimal point

-R suffix = RoHS compliant

## **Dimensions (mm)**



Part marking: FP1309Bx (Product code and size, x = version indicator), Rxxx = Inductance value in uH, <math>R = decimal point

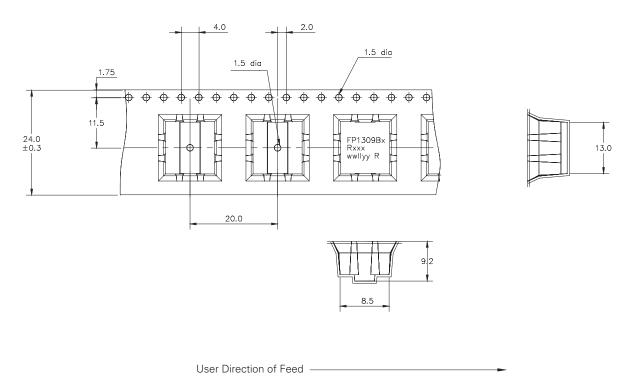
wwllyy = date code, R = revision level

All soldering surface to be coplanar within 0.10mm

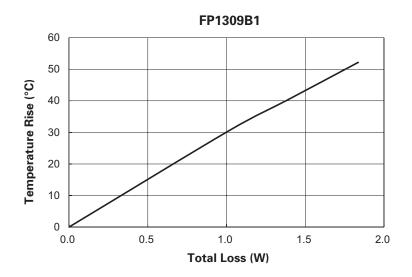
DCR measured between point "a" and point "b"

# Packaging information (mm)

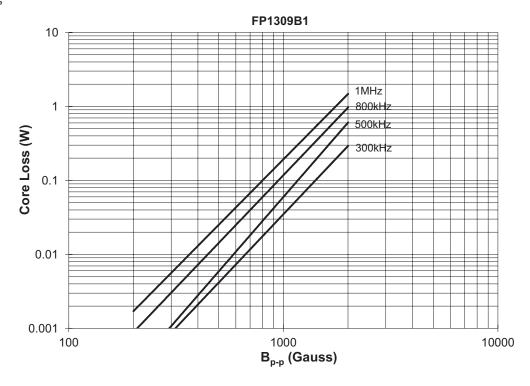
Supplied in tape and reel packaging, 330 parts per 13" diameter reel



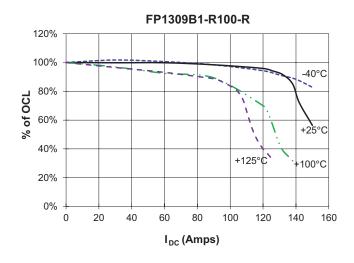
# Temperature rise vs. total loss

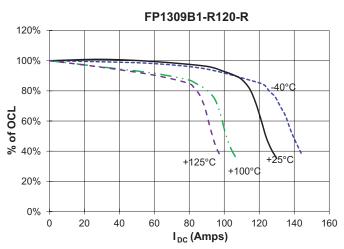


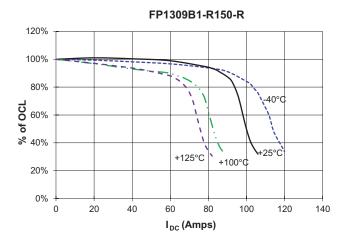
# Core loss vs. B<sub>p-p</sub>



### Inductance characteristics







# Solder reflow profile

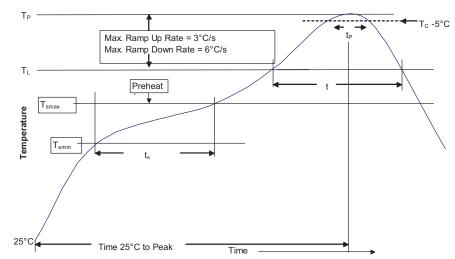


Table 1 - Standard SnPb Solder (T<sub>C</sub>)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T<sub>C</sub>)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

# **Reference JDEC J-STD-020D**

older	
8 Minutes Max.	

 $<sup>^{*}</sup>$  Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup> Tolerance for time at peak profile temperature (t<sub>p</sub>) is defined as a supplier minimum and a user maximum.